

Product Description		2.5mm X 2.0mm SMD TCXO / VCTCXO					
Product Revision							
Product Total Weight		0.014011g/pcs					
Contact Information	Company	Suntsu Frequency Control, Inc.					
	Contact Name	Bob Tintelnot					
	Address	2 South Pointe Dr., Suite 195 Lake Forest, Ca 92630					
	Phone Number	949-305-0220					
Homogenous Component/ Subcomponent	Homogenous Component/ Subcomponent Weight (g)	Substance	CAS number	Substance Weight (g)	PPM Level	PPM Level Availability Date (if Not Available)	Purpose/Location
3225 PKG	0.009973	Alumina-Al ₂ O ₃	1344-28-1	0.0050832380	362801.73		Ceramic
		Silica-SiO ₂	14808-60-7	0.0002672760	19076.07		Ceramic
		Manganese-Mn	7439-96-5	0.000069810	498.25		Ceramic
		Tungsten-W	7440-33-7	0.0016106400	114954.87		Electric conductor
		Molybdenum-Mo	7439-98-7	0.000498650	3558.97		Electric conductor
		Silver-Ag	7440-22-4	0.0001695410	12100.51		Brazing material
		Copper-Cu	7440-50-8	0.000658220	4697.86		Brazing material
		Iron-Fe	1309-37-1	0.0013124470	93672.19		Kovar ring
		Nichel-Ni	7440-02-0	0.0005128120	36600.51		Kovar ring
		Cobalt-Co	7440-48-4	0.0002866240	20456.98		Kovar ring
		Nichel-Ni	7440-02-0	0.0003418740	24400.29		Ni plating
		Cobalt-Co	7440-48-4	0.0001910830	13638.01		Ni plating
Gold-Au	7440-57-5	0.0000747980	5338.50		Au plating		
LID	0.0026173	Iron-Fe	1309-37-1	0.0014002555	99939.28		Alloy
		Nichel-Ni	7440-02-0	0.0007721035	55106.70		Alloy
		Cobalt-Co	7440-48-4	0.0004449410	31756.41		Alloy
Blank	0.000276017	Silica-SiO ₂	14808-60-7	0.0002760167	19699.91		Quartz crystal
Gold	0.000113489	Gold-Au	7440-57-5	0.0001134891	8099.96		Electrode
Gold Wire	4.76374E-05	Gold-Au	7440-57-5	0.0000476374	3399.98		Connect
IC	0.000406319	Silicon Si	7440-21-3	0.0004063190	28999.87		
Silver epoxy [X-tal attach]	0.0003433	Silver-Ag	7440-22-4	0.0002712070	19356.63		Conductive adhesive
		Dodecane	112-40-3	0.0000446290	3185.27		Conductive adhesive
		Silica-SiO ₂	14808-60-7	0.0000274640	1960.17		Conductive adhesive
Silver epoxy [IC attach]	0.000234	Silver-Ag	7440-22-4	0.0001848600	13193.86		Conductive adhesive
		Disphenol F	54208-63-8	0.0000304200	2171.14		Conductive adhesive
		Dipropylcnc glycol monomethyl ether	34590-94-8	0.0000187200	1336.09		Conductive adhesive

0.0140110632 1000000.0000